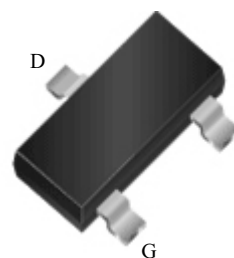


N-Channel, 20V, 0.90A, Small Signal MOSFET

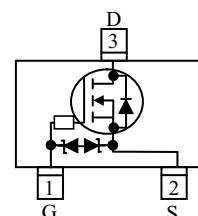
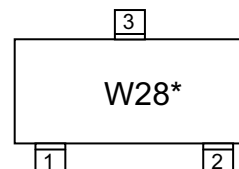
V_{DS} (V)	$R_{ds(on)}$ (Ω)
20	0.220@ $V_{GS}=4.5V$
	0.260@ $V_{GS}=2.5V$
	0.320@ $V_{GS}=1.8V$


SOT-23
Descriptions

The WNM2020 is N-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product WNM2020 is Pb-free and Halogen-free.

Features

- Trench Technology
- Supper high density cell design
- Excellent ON resistance
- Extremely Low Threshold Voltage
- Small package SOT-23


Pin configuration (Top view)


W28 = Device Code

* = Month (A~Z)

Marking
Applications

- DC-DC converter circuit
- Small Signal Switch
- Load Switch
- Level Shift
-

Order information

Device	Package	Shipping
WNM2020-3/TR	SOT-23	3000/Reel&Tape

Absolute Maximum ratings

Parameter		Symbol	10 S	Steady State	Unit
Drain-Source Voltage		V _{DS}	20		V
Gate-Source Voltage		V _{GS}	±6		
Continuous Drain Current ^a	T _A =25°C	I _D	0.90	0.83	A
	T _A =70°C		0.72	0.66	
Maximum Power Dissipation ^a	T _A =25°C	P _D	0.38	0.32	W
	T _A =70°C		0.24	0.20	
Continuous Drain Current ^b	T _A =25°C	I _D	0.79	0.71	A
	T _A =70°C		0.63	0.57	
Maximum Power Dissipation ^b	T _A =25°C	P _D	0.29	0.24	W
	T _A =70°C		0.19	0.15	
Pulsed Drain Current ^c		I _{DM}	1.4		A
Operating Junction Temperature		T _J	-55 to 150		°C
Lead Temperature		T _L	260		°C
Storage Temperature Range		T _{stg}	-55 to 150		°C

Thermal resistance ratings

Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance ^a	$t \leq 10 \text{ s}$	$R_{\theta JA}$	270	325	$^{\circ}\text{C/W}$
	Steady State		320	385	
Junction-to-Ambient Thermal Resistance ^b	$t \leq 10 \text{ s}$	$R_{\theta JA}$	360	420	
	Steady State		425	520	
Junction-to-Case Thermal Resistance		$R_{\theta JC}$	260	300	

a Surface mounted on FR4 Board using 1 square inch pad size, 1oz copper

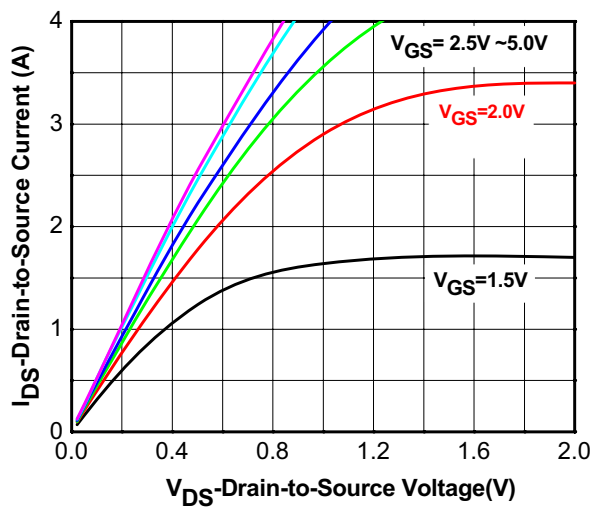
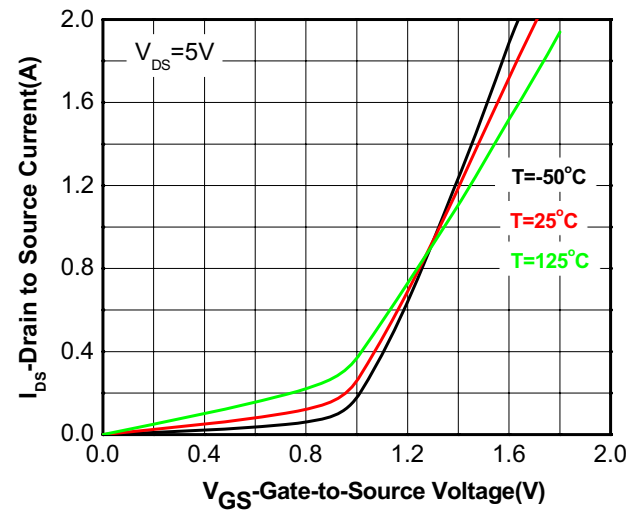
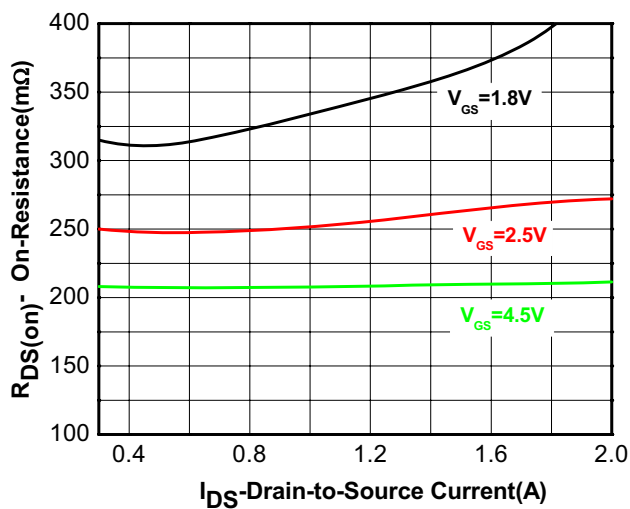
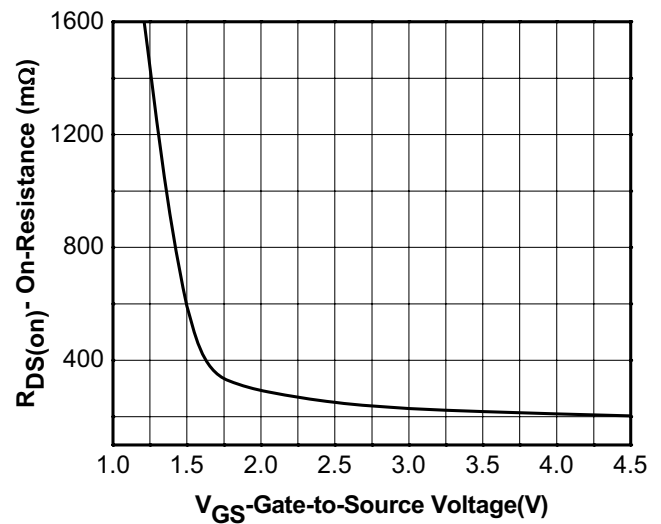
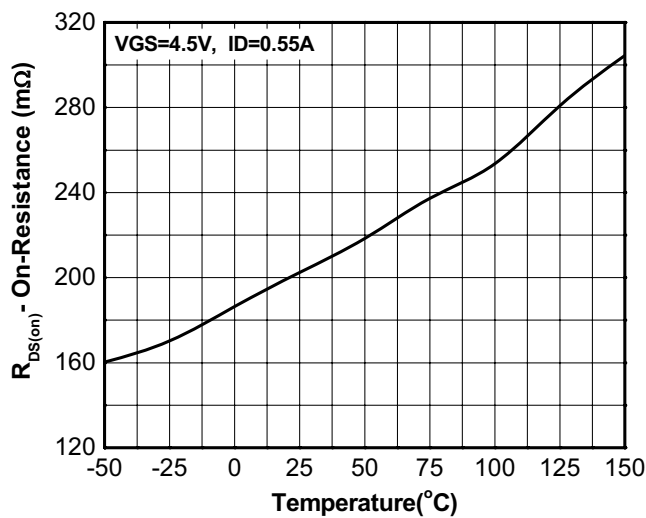
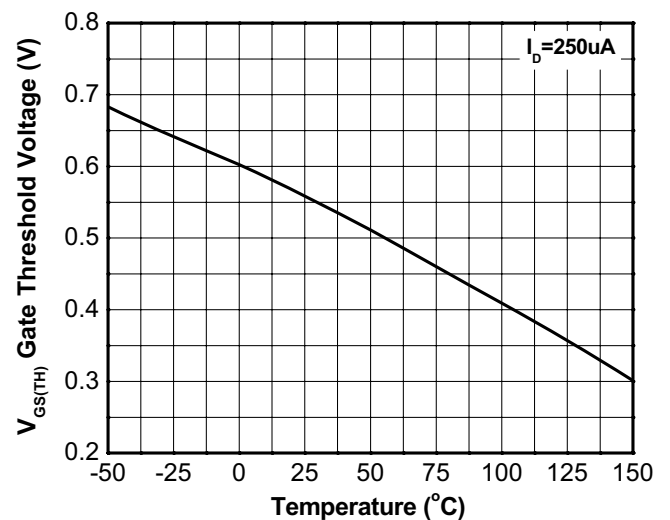
b Surface mounted on FR4 board using minimum pad size, 1oz copper

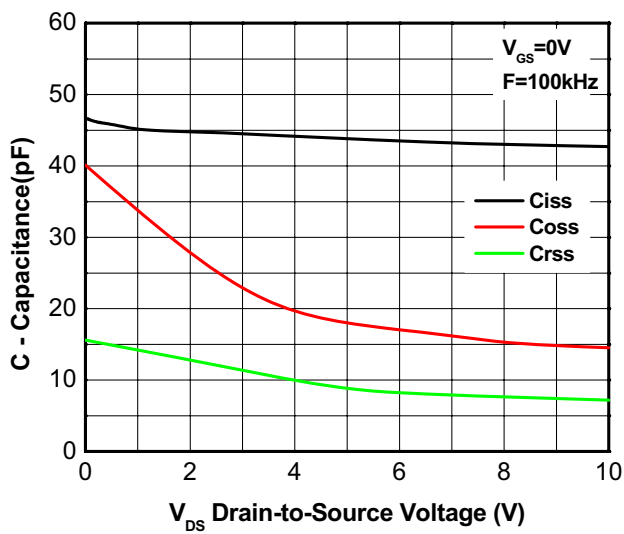
c Repetitive rating, pulse width limited by junction temperature, $t_p=10\mu\text{s}$, Duty Cycle=1%

d Repetitive rating, pulse width limited by junction temperature $T_J=150^{\circ}\text{C}$.

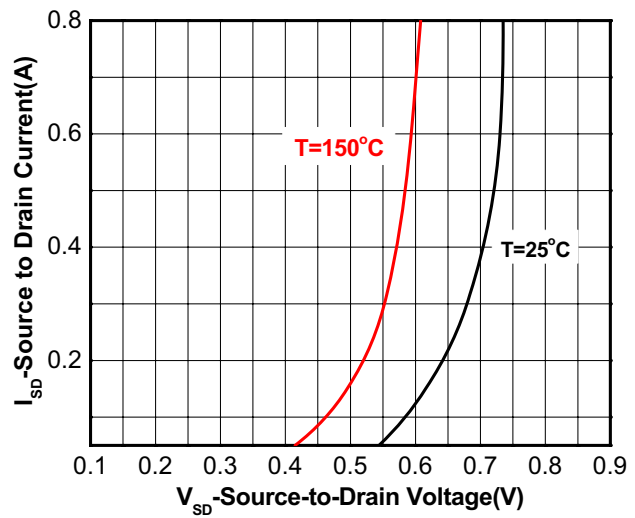
Electronics Characteristics (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0 V, I _D = 250uA	20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =16 V, V _{GS} =0V			1	uA
Gate-to-source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} =±5V			±5	uA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = 250uA	0.45	0.58	0.85	V
Drain-to-source On-resistance	R _{DS(on)}	V _{GS} = 4.5V, I _D = 0.55A		220	310	mΩ
		V _{GS} = 2.5V, I _D = 0.45A		260	360	
		V _{GS} = 1.8V, I _D = 0.35A		320	460	
Forward Transconductance	g _{FS}	V _{DS} = 5 V, I _D = 0.55A		2.0		S
CHARGES, CAPACITANCES AND GATE RESISTANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 100 kHz, V _{DS} = 10 V		50		pF
Output Capacitance	C _{OSS}			13		
Reverse Transfer Capacitance	C _{RSS}			8		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 10 V, I _D = 0.55A		1.15		nC
Threshold Gate Charge	Q _{G(TH)}			0.06		
Gate-to-Source Charge	Q _{GS}			0.15		
Gate-to-Drain Charge	Q _{GD}			0.23		
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	td(ON)	V _{DD} =10V, V _{GS} =4.5V, I _D =0.55A, R _G =6Ω		22		ns
Rise Time	tr			80		
Turn-Off Delay Time	td(OFF)			700		
Fall Time	tf			380		
BODY DIODE CHARACTERISTICS						
Forward Voltage	V _{SD}	V _{GS} = 0 V, I _S = 0.35A	0.5	0.7	1.5	V

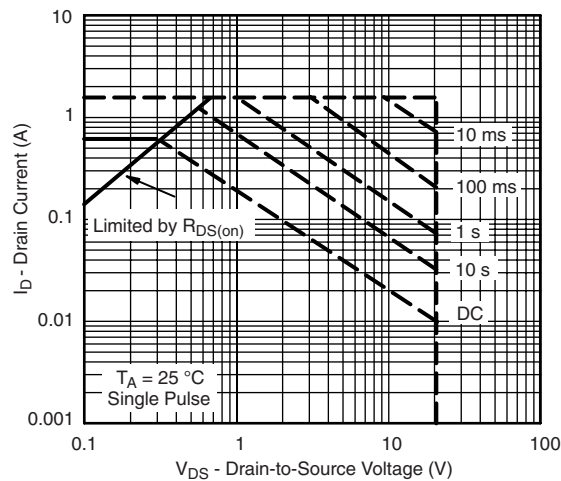
Typical Characteristics ($T_a=25^\circ\text{C}$, unless otherwise noted)

Output characteristics

Transfer characteristics

On-Resistance vs. Drain current

On-Resistance vs. Gate-to-Source voltage

On-Resistance vs. Junction temperature

Threshold voltage vs. Temperature



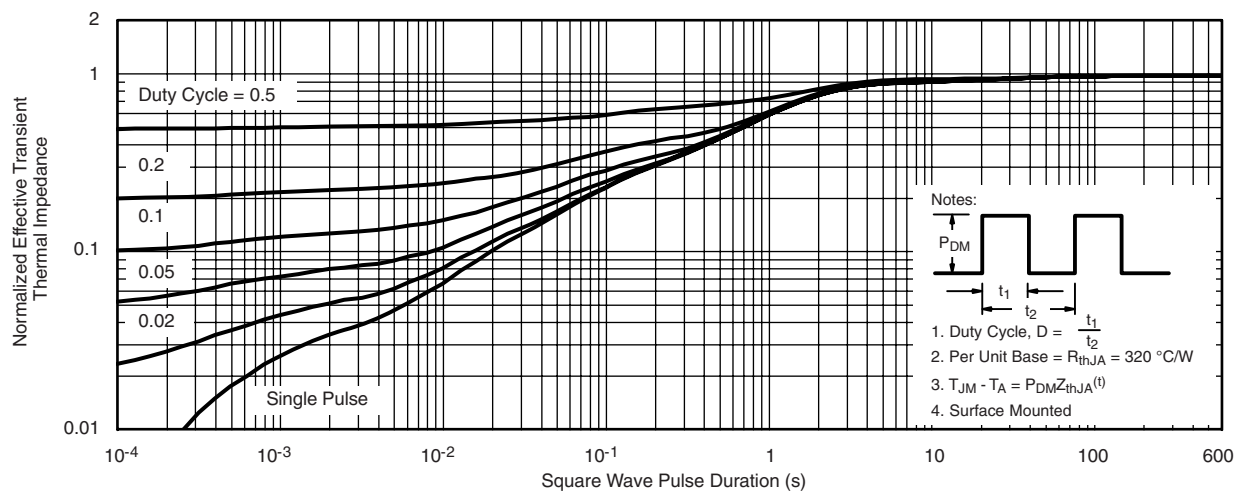
Capacitance



Body diode forward voltage



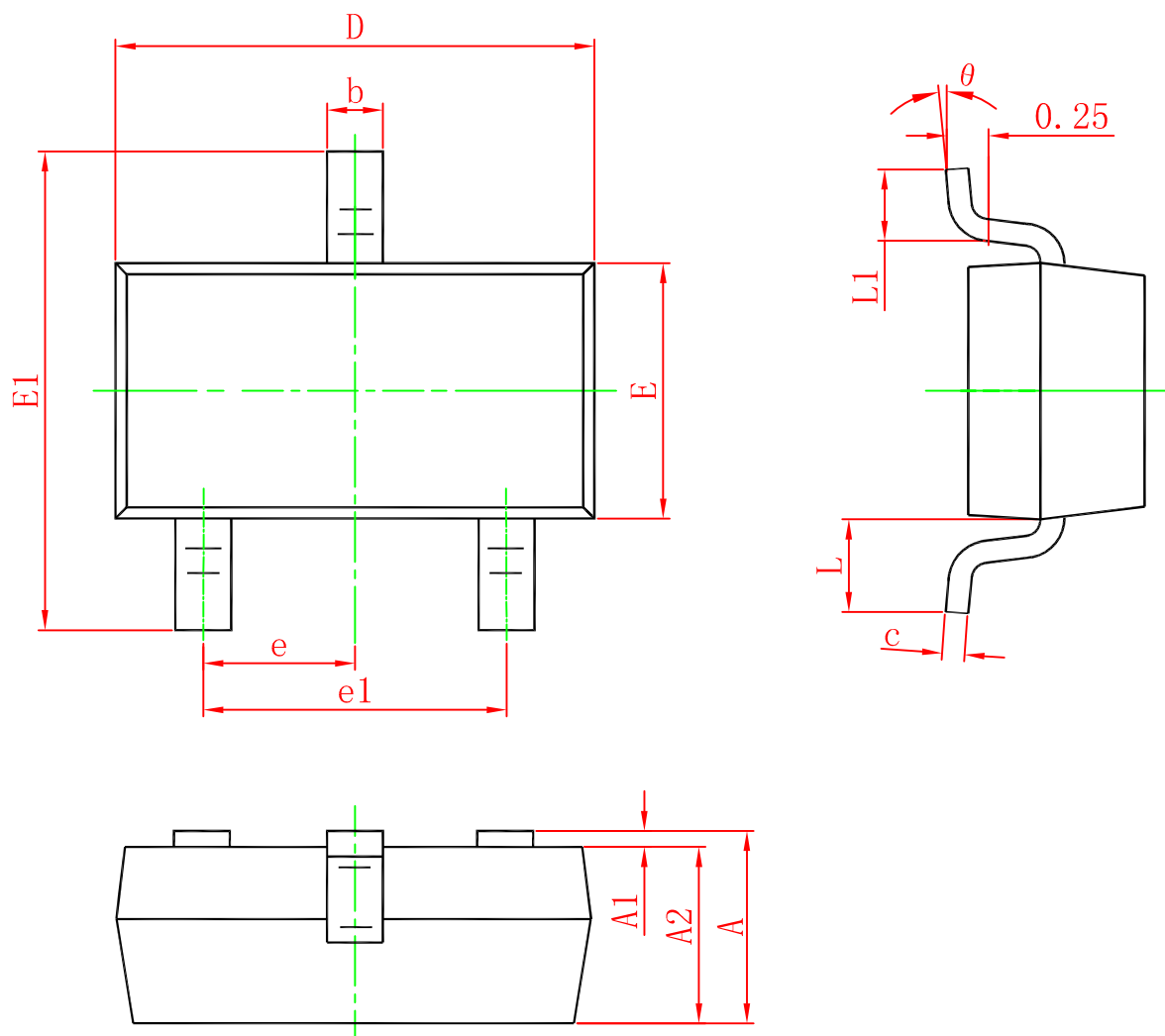
Safe operating power



Transient thermal response (Junction-to-Ambient)

Package outline dimensions

SOT-23



Symbol	Dimensions in millimeter		
	Min.	Typ.	Max.
A	0.900	1.025	1.150
A1	0.000	0.050	0.100
A2	0.900	0.975	1.050
b	0.300	0.400	0.500
c	0.080	0.115	0.150
D	2.800	2.900	3.000
E	1.200	1.300	1.400
E1	2.250	2.400	2.550
e	0.950TYP		
e1	1.800	1.900	2.000
L	0.550REF		
L1	0.300		0.500
θ	0°		8°